

# FUJI POWER MOSFET

## Super FAP-G Series

### ■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

### ■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

### ■ Maximum ratings and characteristic

#### ● (Tc=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit	
Drain-source voltage	VDS	200	V	
	VDSX *5	170	V	
Continuous drain current	Id	±18	A	
Pulsed drain current	Id(puls)	±72	A	
Gate-source voltage	VGS	±30	V	
Non-repetitive Avalanche current	IAS *2	18	A	
Maximum Avalanche Energy	EAS *1	125.5	mJ	
Maximum Drain-Source dV/dt	dVDS/dt *4	20	kV/μs	
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs	
Max. power dissipation	PD	Ta=25°C Tc=25°C	2.16	W
			37	
Operating and storage temperature range	Tch	+150	°C	
	Tstg	-55 to +150	°C	
Isolation voltage	Viso *6	2	kVrms	

\*1 L=620μH, Vcc=48V, Tch=25°C, See to Avalanche Energy Graph    \*2 Tch ≤ 150°C

\*3 If ≤ -Id, -di/dt=50A/μs, Vcc≤BVdss, Tch≤ 150°C    \*4 Vds ≤ 200V    \*5 Vgs=-30V    \*6 t=60sec f=60Hz

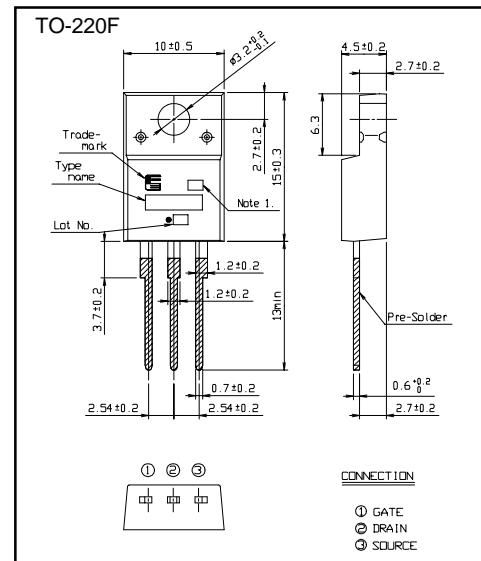
#### ● Electrical characteristics (Tc = 25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id= 250μA VGS=0V	200			V
Gate threshold voltage	VGS(th)	Id= 250μA VDS=VGS	3.0		5.0	V
Zero gate voltage drain current	IdSS	VDS=200V VGS=0V VDS=160V VGS=0V	Tch=25°C Tch=125°C	25	250	μA
Gate-source leakage current	IGSS	VGS=±30V VDS=0V		10		nA
Drain-source on-state resistance	RDS(on)	Id=6.5A VGS=10V	131	170		mΩ
Forward transconductance	gfs	Id=6.5A VDS=25V	5.5	11		S
Input capacitance	Ciss	VDS=75V VGS=0V f=1MHz	770	1155		pF
Output capacitance	Coss		110	165		
Reverse transfer capacitance	Crss		5	7.5		
Turn-on time ton	td(on)	Vcc=48V Id=6.5A VGS=10V RGS=10 Ω	12	18		ns
	tr		2.6	3.9		
Turn-off time toff	td(off)		22	33		
	tf		6.1	9.2		
Total Gate Charge	QG	Vcc=100V Id=13A VGS=10V	21	31.5		nC
Gate-Source Charge	QGS		8	12		
Gate-Drain Charge	QGD		5	7.5		
Avalanche capability	IAV	L=620μH Tch=25°C	18			A
Diode forward on-voltage	VSD	If=13A VGS=0V Tch=25°C		1.10	1.65	V
Reverse recovery time	trr	If=13A VGS=0V -di/dt=100A/μs Tch=25°C		0.15		μs
Reverse recovery charge	Qrr			0.88		μC

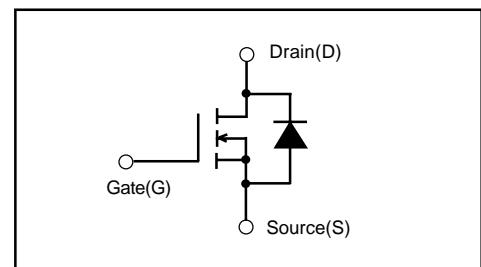
#### ● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			3.378	°C/W
	Rth(ch-a)	channel to ambient			58.0	°C/W

### ■ Outline Drawings (mm)



### ■ Equivalent circuit schematic



## ■ Characteristics

